



N-Channel Insulated Gate Bipolar Power Transistor

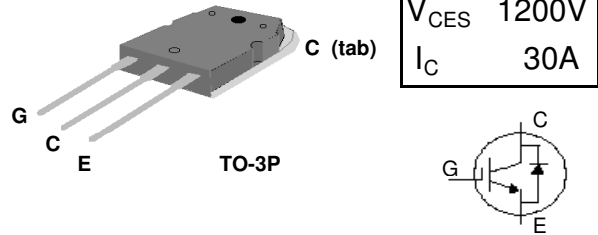
High Speed Switching

Low Saturation Voltage

Typical $V_{CE(sat)} = 2.9V$ at $I_C=30A$

Internal "Co-Pak" Fast Recovery Diode

RoHS-compliant, halogen-free TO-3P package



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GE}	Gate-Emitter Voltage	± 30	V
I_C at $T_C=25^\circ C$	Continuous Collector Current	60	A
I_C at $T_C=100^\circ C$	Continuous Collector Current	30	A
I_{CM}	Pulsed Collector Current ¹	120	A
I_F at $T_C=100^\circ C$	Diode Continuous Forward Current	6	A
I_{FM}	Diode Pulse Forward Current	40	A
P_D at $T_C=25^\circ C$	Maximum Power Dissipation	208	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds .	300	$^\circ C$

Notes:

1.Repetitive rating : Pulse width limited by maximum junction temperature.

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c (IGBT)	Thermal Resistance Junction-Case	0.6	$^\circ C/W$
Rthj-c (Diode)	Thermal Resistance Junction-Case	2.0	$^\circ C/W$
Rthj-a	Thermal Resistance Junction-Ambient	40	$^\circ C/W$

Electrical Specifications at $T_J=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_{GES}	Gate-to-Emitter Leakage Current	$V_{GE}=\pm 30V, V_{CE}=0V$	-	-	± 500	nA
I_{CES}	Collector-Emitter Leakage Current	$V_{CE}=1200V, V_{GE}=0V$	-	-	1	mA
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=30A$	-	2.9	3.6	V
		$V_{GE}=15V, I_C=60A$	-	3.7	-	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE}=V_{GE}, I_C=250\mu A$	3	-	7	V
Q_g	Total Gate Charge	$I_C=30A$	-	63	100	nC
Q_{ge}	Gate-Emitter Charge	$V_{CC}=500V$	-	12	-	nC
Q_{gc}	Gate-Collector Charge	$V_{GE}=15V$	-	32	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V,$	-	40	-	ns
t_r	Rise Time	$I_C=30A,$	-	45	-	ns
$t_{d(off)}$	Turn-off Delay Time	$V_{GE}=15V,$	-	125	-	ns
t_f	Fall Time	$R_G=5\Omega,$	-	430	860	ns
		Inductive Load	-	1.3	-	mJ
E_{on}	Turn-On Switching Loss		-	3.1	-	mJ
E_{off}	Turn-Off Switching Loss		-	-	-	mJ
C_{ies}	Input Capacitance	$V_{GE}=0V$	-	1400	2240	pF
C_{oes}	Output Capacitance	$V_{CE}=30V$	-	120	-	pF
C_{res}	Reverse Transfer Capacitance	$f=1.0MHz$	-	15	-	pF

Electrical Characteristics of Diode at $T_J=25^\circ C$ (unless otherwise specified)

V_{F-1}	Forward Voltage	$I_F=6A$	-	2.6	3	V
V_{F-2}	Forward Voltage	$I_F=20A$	-	-	4	V
t_{rr}	Reverse Recovery Time	$I_F=10A$	-	54	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt = 100 A/\mu s$	-	138	-	nC

Ordering Information

AP30G120ASW-3TB

RoHS-compliant halogen-free TO-3P, shipped in tubes (30pcs/tube)



Typical Electrical Characteristics

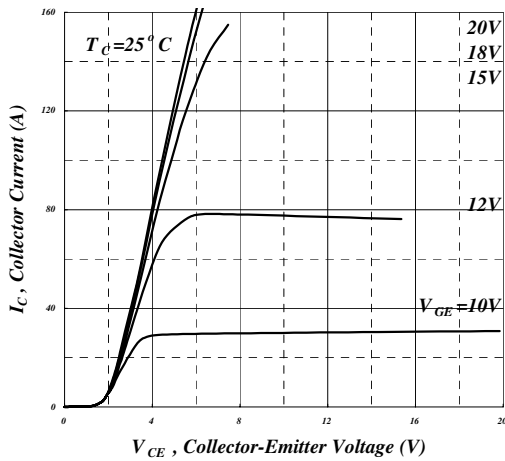


Fig 1. Typical Output Characteristics

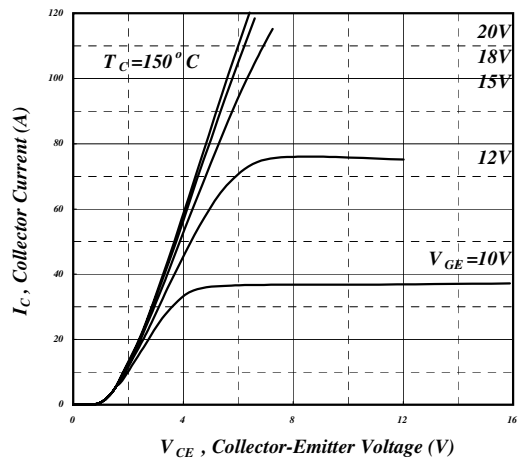


Fig 2. Typical Output Characteristics

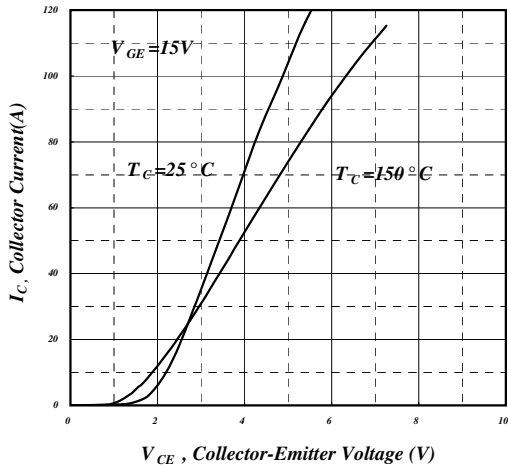


Fig 3. Typical Saturation Voltage Characteristics

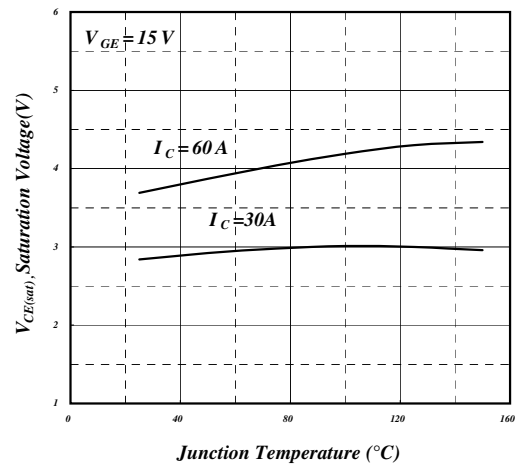


Fig 4. Typical Collector-Emitter Voltage vs. Junction Temperature

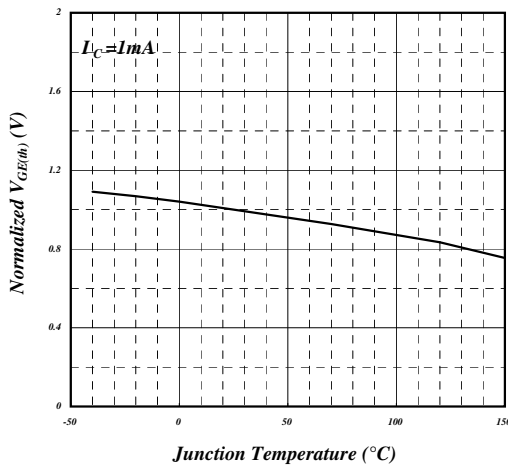


Fig 5. Gate Threshold Voltage vs. Junction Temperature

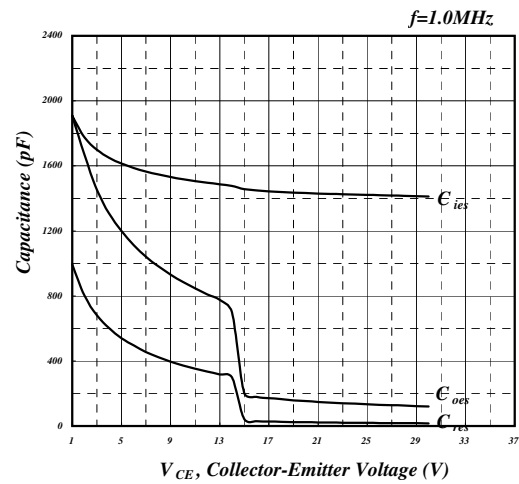


Fig 6. Typical Capacitance Characteristics



Typical Electrical Characteristics (cont.)

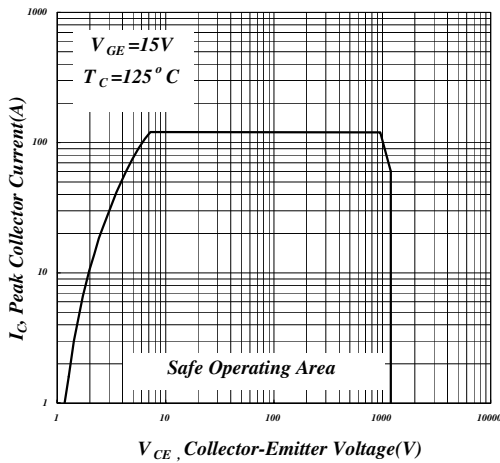


Fig 7. Turn-off SOA

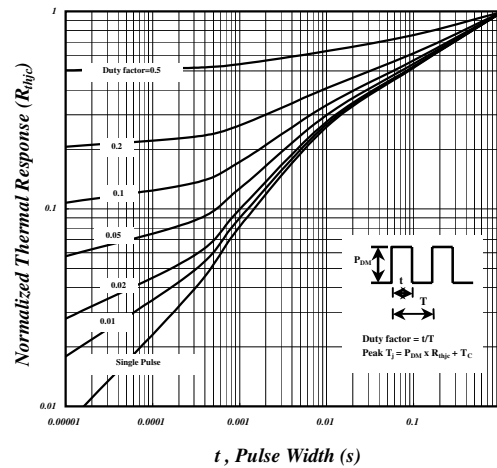


Fig 8. Effective Transient Thermal Impedance

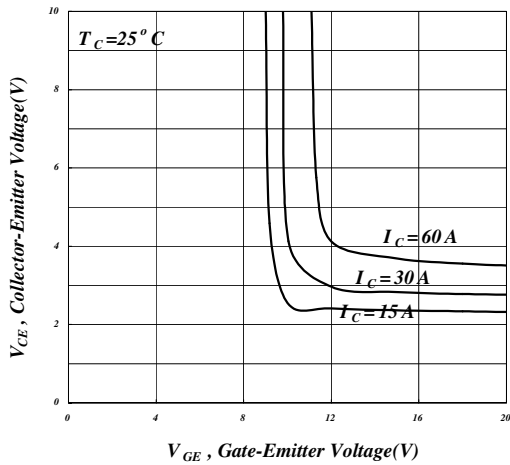


Fig 9. Saturation Voltage vs. V_{GE}

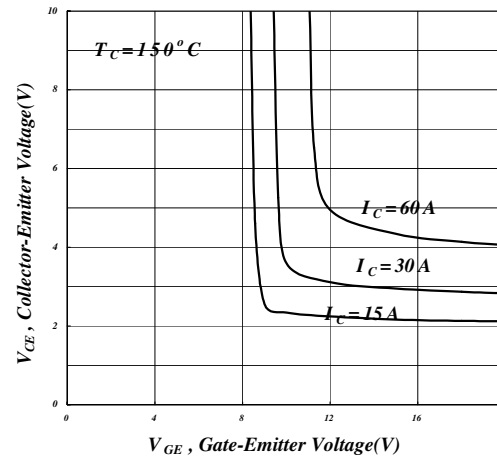


Fig 10. Saturation Voltage vs. V_{GE}

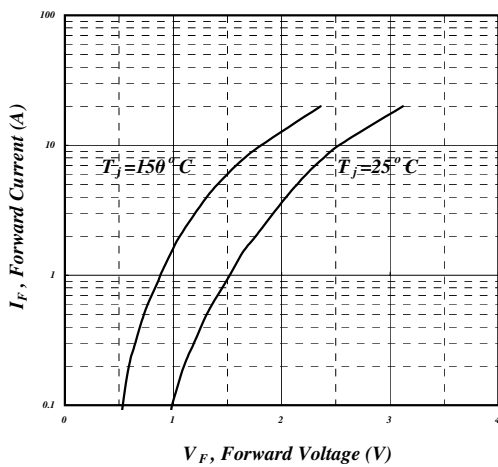


Fig11. Forward Characteristics of the Co-packaged Diode

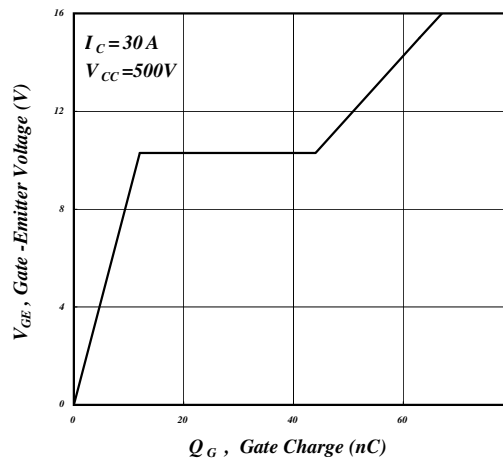


Fig 12. Gate Charge Characteristics



Typical Electrical Characteristics (cont.)

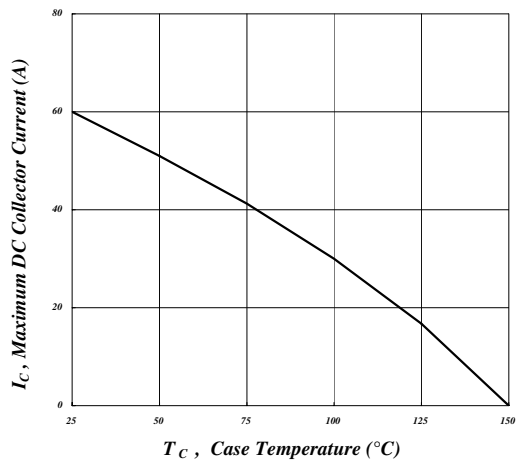
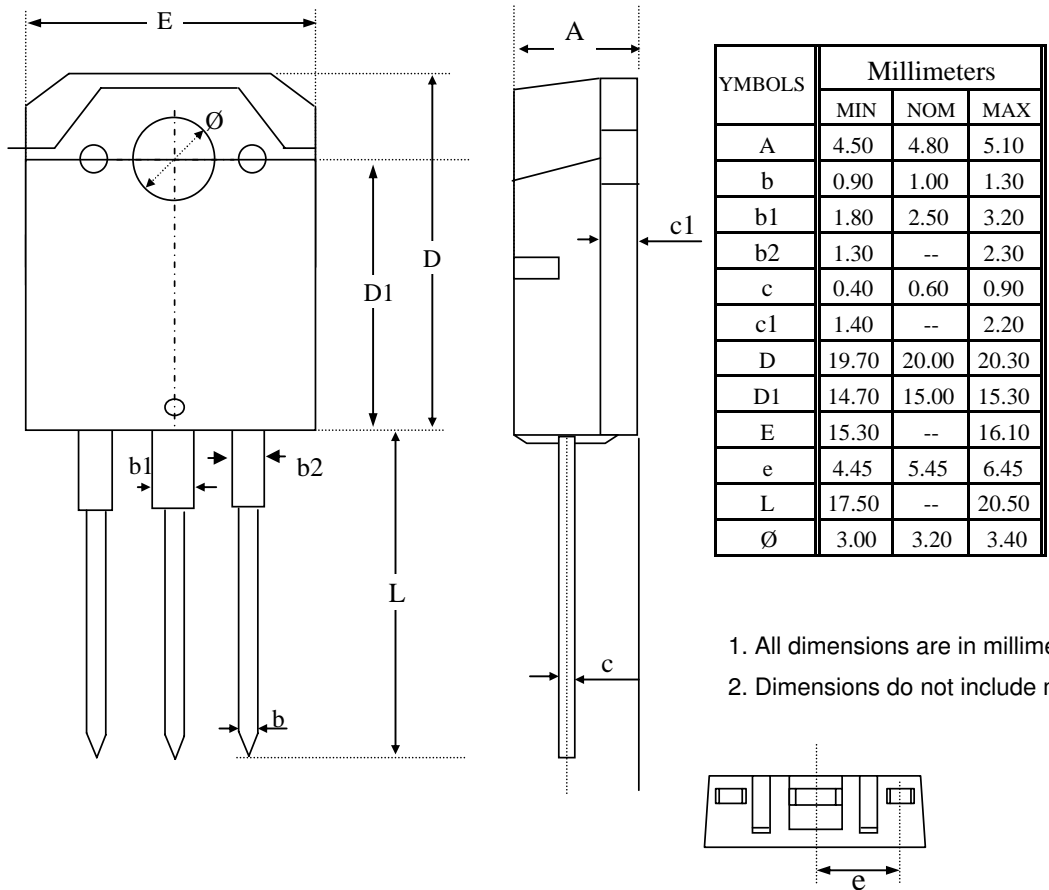


Fig 13. Maximum Collector Current
vs. Case Temperature



Package Dimensions: TO-3P



1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information:

Laser Marking

